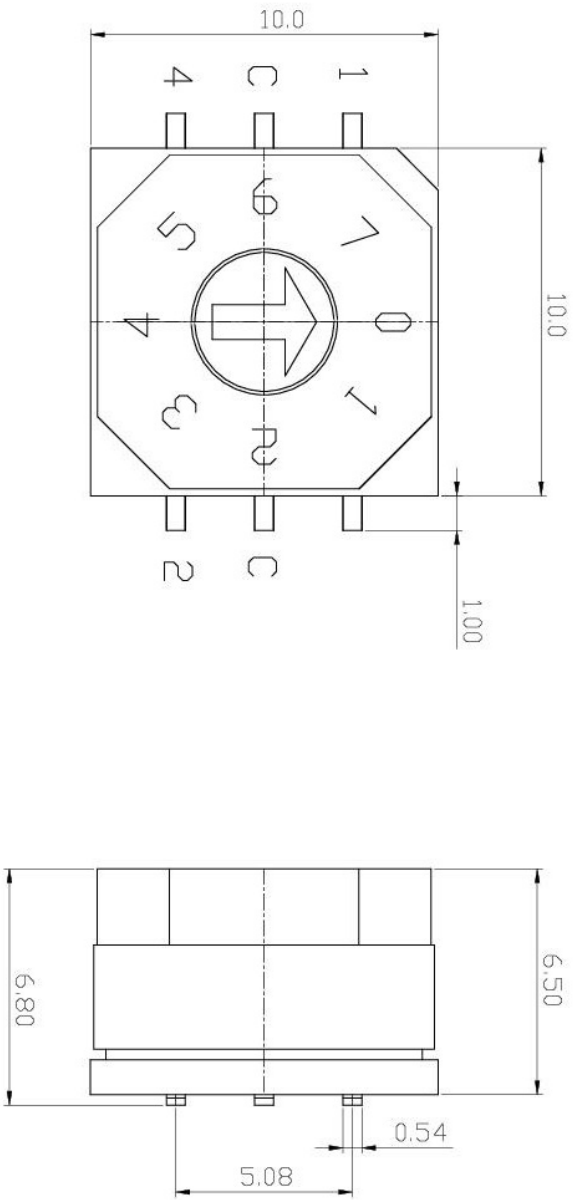


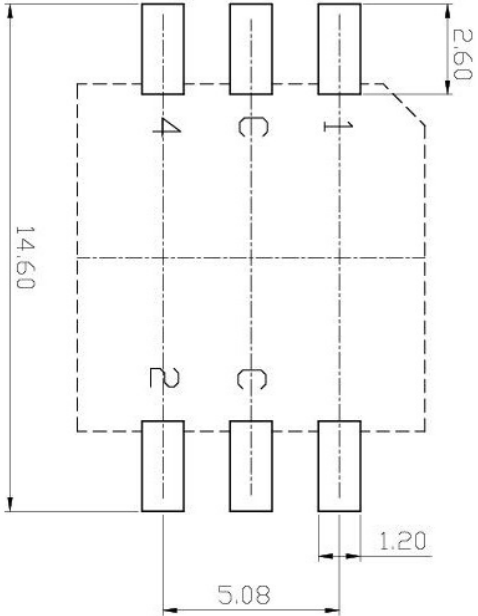
WORK	DATE	REMARKS
△		
△		



SPECIFICATION

1. Rating : 150mA, 42V DC (Switching)
200mA, 42V DC (None-Switching)
2. Contact Resistance : 80mΩ Max
3. Insulation Resistance : 100MΩ Min
4. Operating Force : 700gf Max
5. Life cycle : 10,000 steps

Real Coded				
	C	1	2	4
0	●			
1	●	●		
2	●		●	
3	●			●
4	●			
5	●	●		●
6	●		●	●
7	●	●	●	●



P.C.B DIMENSION

A'PPD	CHKD	D'SCD	TITLE	
K.L LEE	J.P ROH	M.H LEE	ROTARY DIP SWITCH	
			MODEL NO.	SDR-08S
			REV	B
SUNG MUN ELECTRONICS CO., LTD.				



ROTARY DIP SWITCH SPECIFICATION

Rev. B
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1. Style:

This specification describes "Rotary Switch" mainly used as signal switch of electric devices with the general requirements of mechanical and electrical characteristics.

1.1 Operating / Storage Temperature Range : -60℃ ~ +125℃

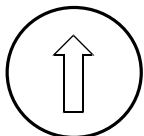
2. Current Range:

2.1 None-Switching : 200 mA, 42V

2.2 Switching : 150 mA, 42V

3. Type of Actuation : Rotating

4. Test Sequence :

E L E C T R I C P E R F O R M A N C E	ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
	1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product
	2	Contact Resistance	① To be measured between the two terminals associated with each switch pole ② Measurements shall be made with a 1kHz shall current contact resistance meter	80mΩ max.(initial)
	3	Insulation Resistance	250V DC, 1minute ±5seconds	100MΩ min
	4	Dielectric withstanding Volotage	250V AC(50Hz or 60Hz)shall be applied between all the adjacent terminal and between the terminal and the frame For 1 minute	There shall be no breakdown or flashover
M A C H I N	5	Operation Force	Applied in the direction of operation 	700gf/cm. max



ROTARY DIP SWITCH SPECIFICATION

Rev. B
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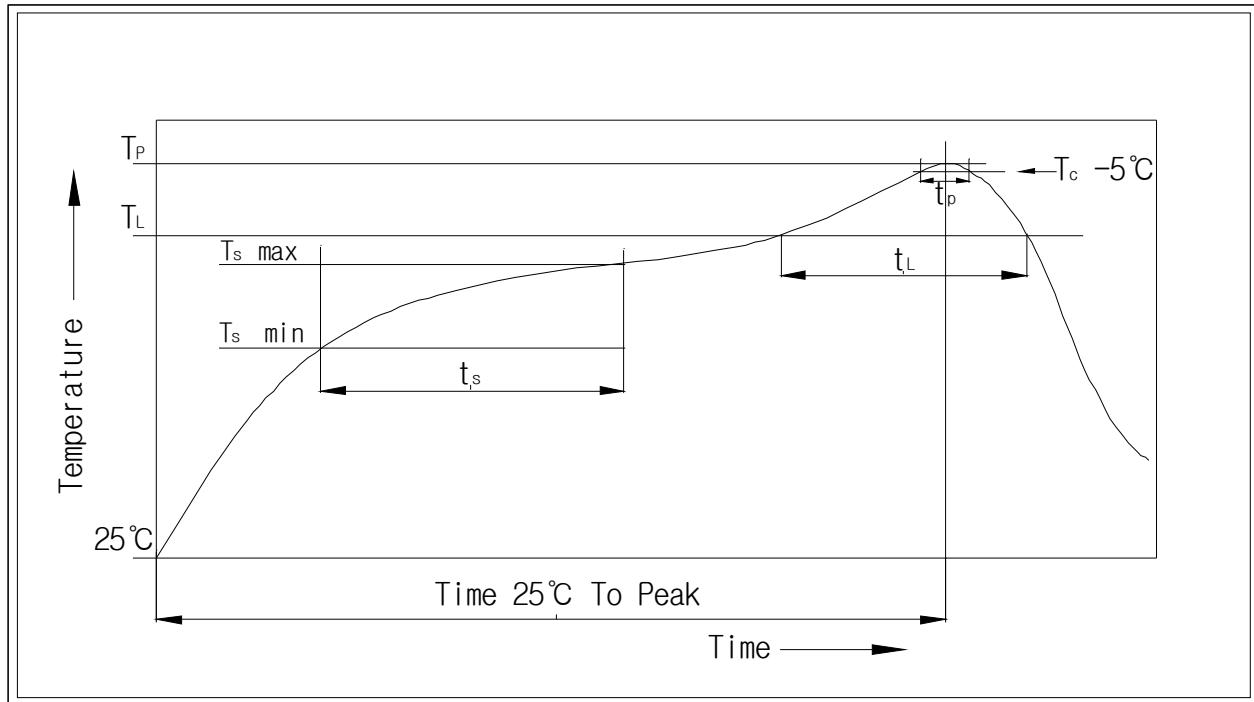
P E R F O R M A N C E	6	Operation Life	Measurements shall be made following the test set forth below: 1)150mA, 42V DC resistive load 2)Rate of operation: 15~20 cycles/ minute 3)Step of operation: 10,000 steps	1)As shown in item 3,4 2)Contact Resistance: 200mΩ max 3)Final-after test
	7	Resistance Low Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: -60℃ ±3℃ 2)Time: 96 hours	As shown in item 2~5
	8	Resistance High Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 125℃ ±2℃ 2)Time: 96 hours	1)As shown in item 3~5 2)Contact Resistance: 200mΩ max
W E A T H E R P R O O F	9	Resistance Humidity	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 40℃ ±2℃ 2)Relative humidity: 90~95% 3)Time: 96 hours	1)As shown in item 4 2)Contact Resistance: 200mΩ max 3)Insulation Resistance: 10MΩ min



ROTARY DIP SWITCH SPECIFICATION

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5. Reflow Soldering Conditions:



1) Classification Reflow Profiles

Profile Feature	Pb-Free Assembly
Average Ramp-UP Rate(Ts max to TP)	3°C/second max
Preheat - Temperature Min(Ts min) - Temperature Max(Ts max) - Time (ts min to ts max)	150°C 200°C 60-180seconds
Time maintained above: - Temperature (TL) - Time (tL)	217°C 60-150seconds
Peak/Classification Temperature(TP)	260°C +0°C/ -5°C
Time within 5°C of actual Peak Temperature(tp)	min 30 seconds
Ramp-Down Rate	6°C/sec max
Time 25°C to Peak Temperature	8 minutes max

6. This item is "ROHS" Compliant



ROTARY DIP SWITCH SPECIFICATION

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7. Part List

NO	PART NAME	Q'TY	MATERIALS	TREATMENT	REMARK
1	COVER	1	LCP		Print
2	BASE	1			
3	ACTUATOR	1	PA66, STS		
4	CONTACT & TERMINAL	1	PHOSPHOR BRONZE	CONTACT AND TERMINAL PLATING: GOLD PLATING OVER NICKEL	Au 0.07 μ m Min Ni 0.1 μ m Min
5	PCB	1	EPOXY	PLATING: GOLD PLATING	Au 0.05 μ m Min
6	O-Ring	1	SILICONE		